

CUSTOMER : _____.

DATE : 2012. 04. 03.

SPECIFICATIONS FOR APPROVAL

Preliminary

3535 Ceramic PKG

MODEL NAME : LEMWA33X70IW00

| APPROVAL | REMARK | APPENDIX |
|----------|--------|----------|
| | | |

| Designed | Checked | Approved |
|----------|---------|----------|
| | | |

SPECIFICATION

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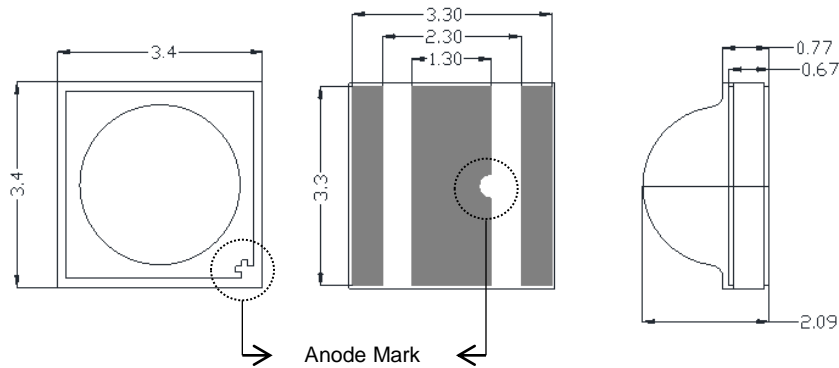
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1. Features

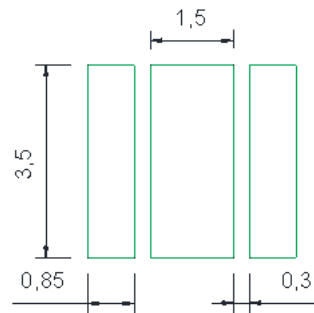
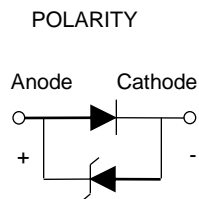
- Lighting Color : Warml White
- Ceramic PKG type : 3.4×3.4×2.09 mm (L×W×H)
- Viewing angle : 115°
- Thermal Resistance (Rthj-s) : 6 °C/W
- Chip Material : InGaN
- Soldering methods : IR reflow soldering
- ESD withstand voltage : up to 2kV according to JESD22-A 114-B

2. Outline Dimensions

(unit : mm)



Recommendable soldering pattern
(For reflow soldering)



▪ Tolerances Unless Dimension ±0.13mm

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3. Applications

- Interior and Exterior Illumination, Automotive Lighting

4. Absolute Maximum Ratings

(Ta=25°C)

| Items | Symbols | Ratings | Unit |
|---------------------------------------|-----------|-----------|------|
| Forward Current* ¹⁾ | I_F | 1,500 | mA |
| Pulse Forward Current * ²⁾ | I_{FP} | 1,500 | mA |
| Power Dissipation | P_D | 5,200 | mW |
| Operating Temperature | T_{opr} | -40 ~ 85 | °C |
| Storage Temperature | T_{stg} | -40 ~ 100 | °C |
| Junction Temperature* ³⁾ | T_j | 150 | °C |
| ESD | | 2 | KV |

*1) $T_s=60^\circ\text{C}$ (@ $T_a=25^\circ\text{C}$)

*2) $T_a=25^\circ\text{C}$

*3) $I_F=1\text{A}$, $T_s=120^\circ\text{C}$ (@ $T_a=85^\circ\text{C}$)

5. Electro - Optical Characteristics

(Ta=25°C)

| Items | Symbol | Condition | Min | Typ | Max | Unit |
|--|-----------------|-----------|-----------------------------------|-----|-----|------|
| Forward Voltage | V_F | 350mA | 2.9 | 3.1 | 3.3 | V |
| Reverse Voltage (Zener Diode)* ¹⁾ | V_R | 350mA | - | - | 6.5 | V |
| Luminous Flux | Φ_V | 350mA | 85 | - | - | lm |
| CIE Value | X / Y | 350mA | Refer to '6. Rank Sorting Method' | | | - |
| Viewing Angle | $2\theta_{1/2}$ | 350mA | - | 112 | - | deg |
| Color Rendering Index | Ra | 350mA | 70 | - | - | - |
| Thermal resistance | Rth | | - | 6 | - | °C/W |

*1) The value is based on performance of Zener Diode.

※ These values are measured with measurement equipment of LG Innotek Co., LTD and tolerances are followings as below
 - Luminous Flux (Φ_V) : $\pm 10\%$, Forward Voltage(V_F) : ± 0.1 , CIE Value : ± 0.005 , CRI Value : ± 3 , Viewing Angle : $\pm 5^\circ$

※ All PKG are tested by LG Innotek equipment. But, the values of characteristics of PKG could be different depending on the test equipment.

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5. Electro - Optical Characteristics

| If (mA) | Vf (V) | Power (W) | Flux (lm) | lm/W |
|---------|--------|-----------|-----------|-------|
| 350 | 2.98 | 1.043 | 115 | 110.3 |
| 700 | 3.16 | 2.215 | 194 | 87.9 |
| 1000 | 3.30 | 3.295 | 250 | 75.9 |
| 1500 | 3.48 | 5.211 | 331 | 63.4 |

* lm values are representative references only.

6. Rank Sorting Method

▪ Rank of Luminous Flux (@ 350mA)

| Rank | Φ (lm, @ 350mA) | | |
|------|-----------------|-----|-----|
| | Min | Typ | Max |
| W3 | 97 | - | - |
| X1 | 100 | - | - |
| X2 | 107 | - | - |
| X3 | 114 | - | - |
| X4 | 122 | - | - |

▪ Rank of CIE Value (@ 350mA)

| CCT | Rank | CIE X | CIE Y |
|---------------------------|------|--------|--------|
| 4500K (4503K± 243K) | I1 | 0.3548 | 0.3736 |
| | | 0.3641 | 0.3804 |
| | | 0.3611 | 0.3638 |
| | | 0.3526 | 0.3575 |
| | I2 | 0.3526 | 0.3575 |
| | | 0.3611 | 0.3638 |
| | | 0.3590 | 0.3521 |
| | | 0.3512 | 0.3465 |
| | I3 | 0.3641 | 0.3804 |
| | | 0.3736 | 0.3874 |
| | | 0.3697 | 0.3697 |
| | | 0.3611 | 0.3638 |
| | I4 | 0.3611 | 0.3638 |
| | | 0.3697 | 0.3697 |
| | | 0.3670 | 0.3578 |
| | | 0.3590 | 0.3521 |

▪ Rank of Forward Voltage (@ 350mA)

| Rank | V _F (V, @ 350mA) | | |
|------|-----------------------------|-----|-----|
| | Min | Typ | Max |
| 0 | 2.9 | - | 3.0 |
| 1 | 3.0 | - | 3.1 |
| 2 | 3.1 | - | 3.2 |

▪ Rank of CRI (@ 350mA)

| Rank | Ra (CRI, @ 350mA) | | |
|------|-------------------|-----|-----|
| | Min | Typ | Max |
| 80 | 70 | - | - |

Rank name method : Please refer to the following example

Rank Name : X1 – 1 –I1

Φ_v rank = X1, V_F Rank = 1, CIE rank = I1

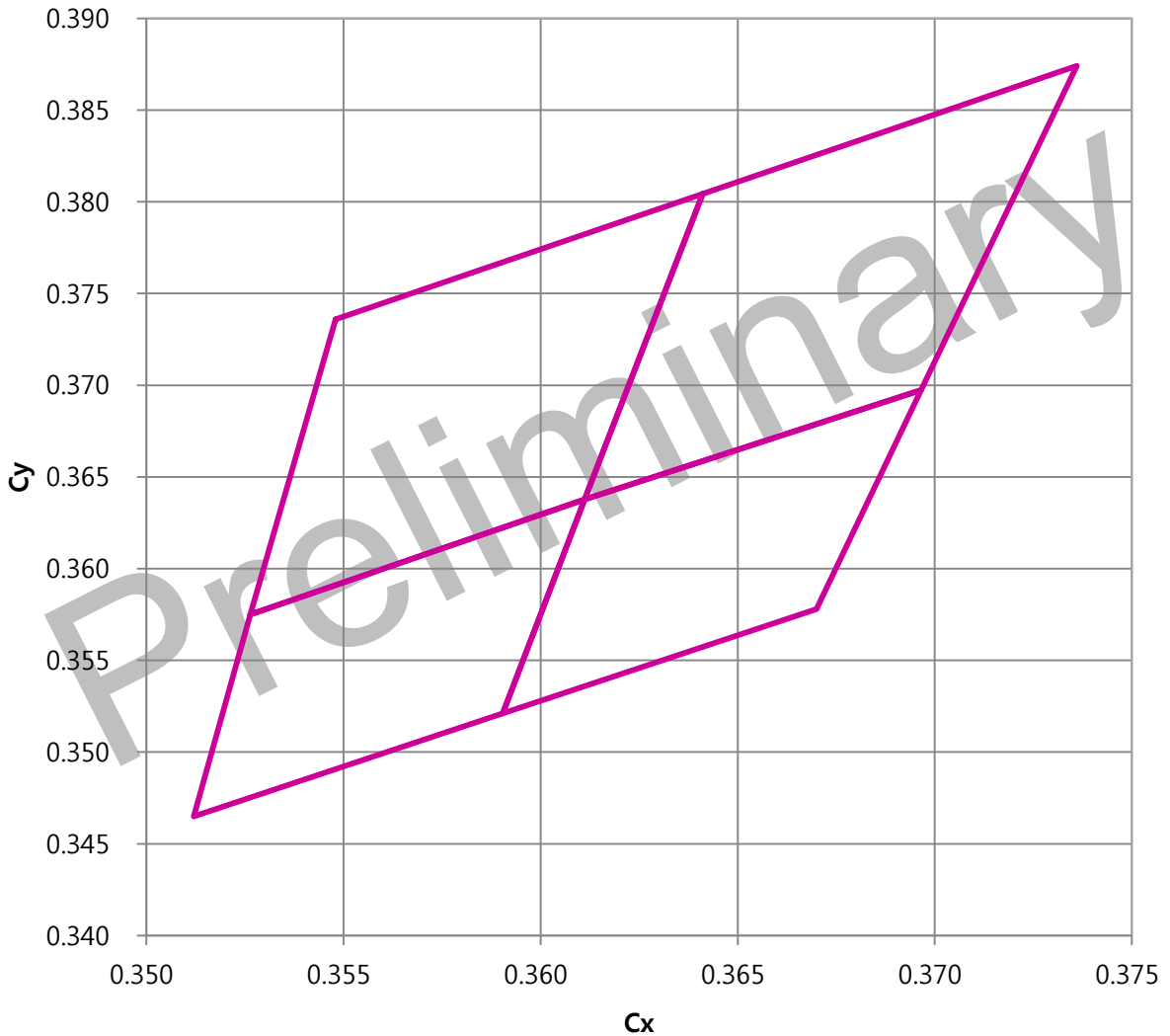
* Voltages are tested at a current pulse duration of 10 ms and an accuracy of ± 5.0%.

* This categories are established for classification of products.

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Chromaticity Diagram



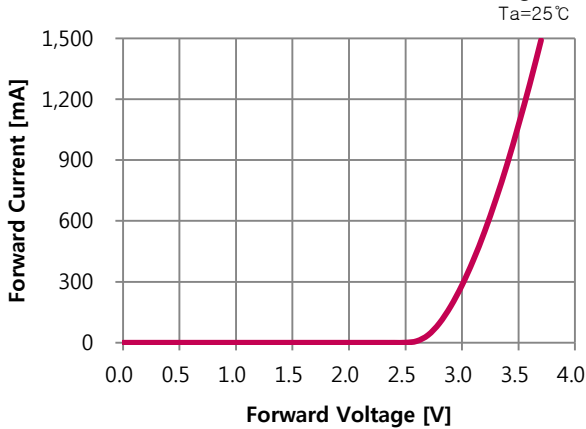
- Chromaticity coordinate groups are tested at a current pulse duration of 10 ms and a tolerance of ± 0.005 .
- This categories are established for classification of products.
- Color Coordinate is based on the CIE 1931 Chromaticity Diagram

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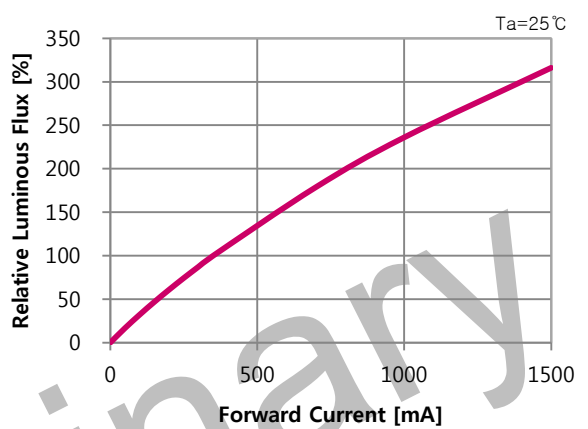
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7. Typical Characteristic Curves

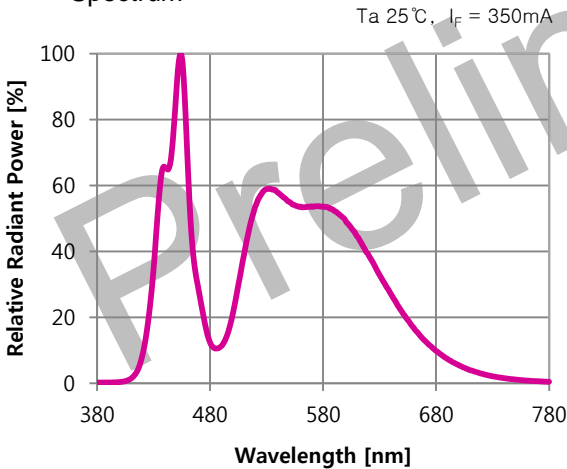
▪ Forward Current vs. Forward Voltage



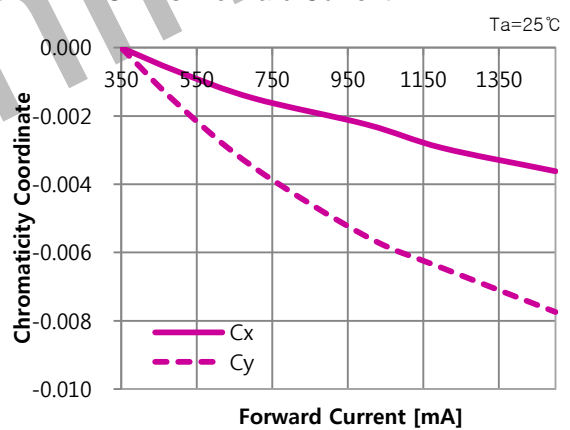
▪ Relative Luminous Flux vs. Forward Current



▪ Spectrum

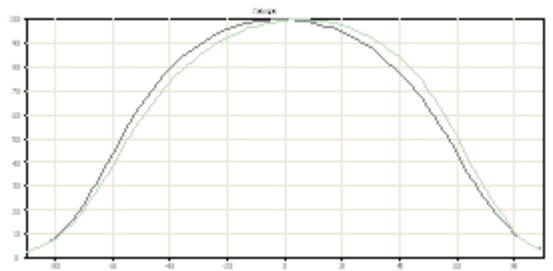
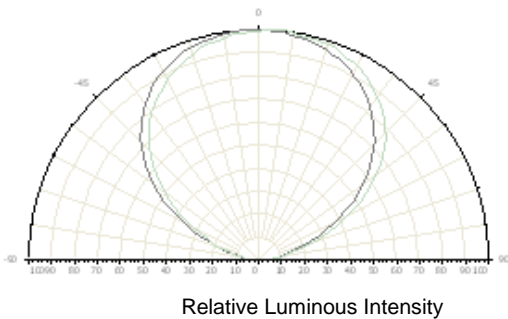


▪ CIE vs. Forward Current



▪ Radiation Characteristics

Ta 25°C, I_F = 350mA

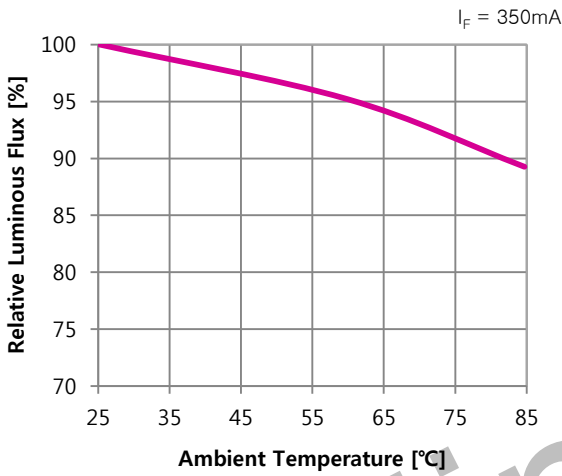


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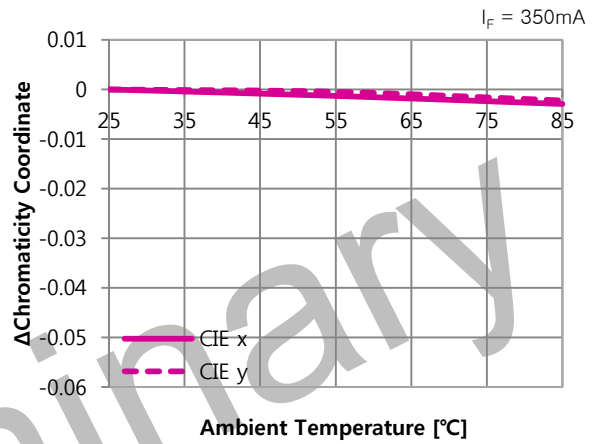
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7. Typical Characteristic Curves

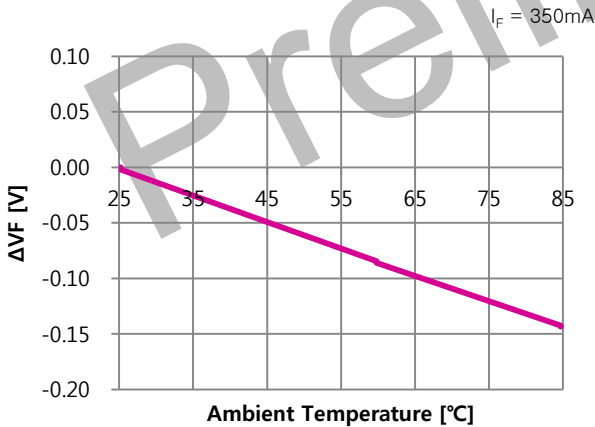
- Luminous Flux vs. Ambient Temp.



- CIE vs. Ambient Temp.



- ΔV_F vs. Ambient Temp.



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8. Reliability Test Items and Conditions

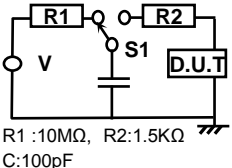
8-1.Criteria for Judging the Damage

| Item | Symbol | Test Condition | Limit | |
|-----------------|----------|----------------|---------|-------------|
| | | | Min | Max |
| Forward Voltage | VF | IF = 350mA | - | U.S.L.× 1.3 |
| Luminous Flux | Φ_V | IF = 350mA | S × 0.7 | - |

*U.S.L : Upper Spec Limit, *L.S.L : Lower Spec Limit *S : Initial Value

※ The Reliability criteria of ESD Test is judged by VF shift ($\pm 0.2V@8mA$) or impedance(Ω) check data.

8-2. Item and Results of Reliability Test

| No | Item | Test Condition | Test Hours/ Cycles | Sample No | Ac/Re |
|----|---|---|-----------------------|--------------|-------|
| 1 | Steady State Operating Life | Ta=25°C, IF=1500 [mA] | 1000hr | 11 pcs | 0 / 1 |
| 2 | High Temp. Humidity Life | Ta=85°C, 85% RH, IF=1000 [mA] | 1000hr | 11 pcs | 0 / 1 |
| 3 | Steady State Operating Life of High Temperature 1 | Ta=85°C, IF=1000 [mA] | 1000hr | 11 pcs | 0 / 1 |
| 4 | Steady State Operating Life of Low Temperature | Ta=-40°C, IF=1000 [mA] | 1000hr | 11 pcs | 0 / 1 |
| 5 | High Temp. Storage | Ta=100°C | 1000hr | 11 pcs | 0 / 1 |
| 6 | Low Temp. Storage | Ta=-40°C | 1000hr | 11 pcs | 0 / 1 |
| 7 | Temperature Cycle | -40°C (30min) ~ 25°C (5min) ~ 100°C (30min) ~ 25°C (5min) | 100cycle | 11 pcs | 0 / 1 |
| 8 | Thermal Shock | 100°C (15min) ~25°C (5min) ~ -40°C (15min) | 100cycle | 11 pcs | 0 / 1 |
| 9 | Resistance to Soldering Heat (Reflow Soldering) | Tsld=260°C, 10sec /2times (Pre Treat. 30°C, 70%, 168hr) | 2 times | 11 pcs | 0 / 1 |
| 10 | Electrostatic Discharge (HBM, $\pm 5kV$) |  <p>R1 :10MΩ, R2:1.5KΩ C:100pF</p> | 3times | 11 pcs | 0 / 1 |
| 11 | Vibration | 100~2000~100Hz sweep 4min, 200m/s ² , 3directions, 4cycles | 48 min. | 11 pcs | 0 / 1 |

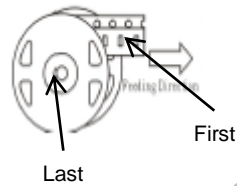
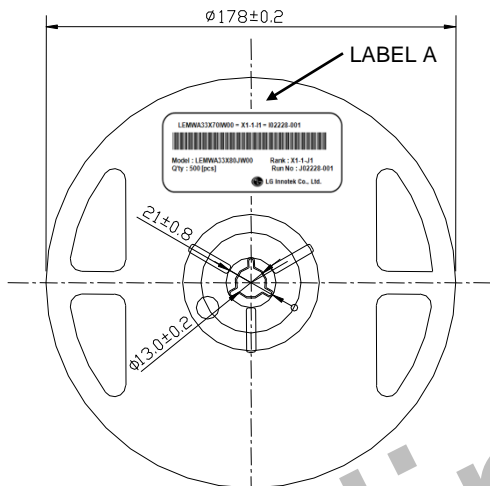
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9. Package and Marking of Products

9-1. Taping Outline Dimension

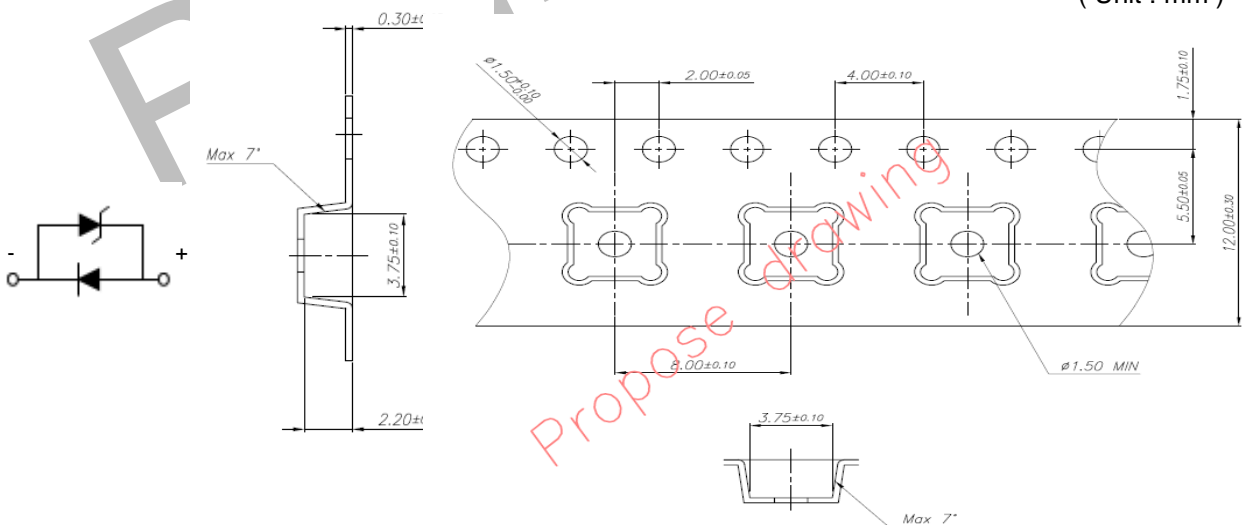
Dimension of Reel



- ◆ Empty Reel Length
- First : 55cm
- Last : 38 cm

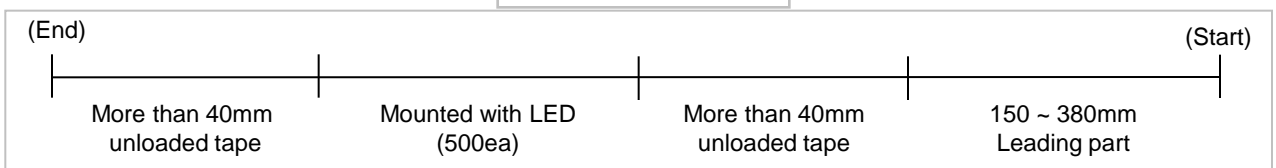
- ◆ Packing Materials :
- Reel : Conductive PS (black)
- Emboss Tape : Conductive PS (black)
- Cover Tap : Conductive PET base

Dimension of Tape



(Unit : mm)

Arrangement of Tape

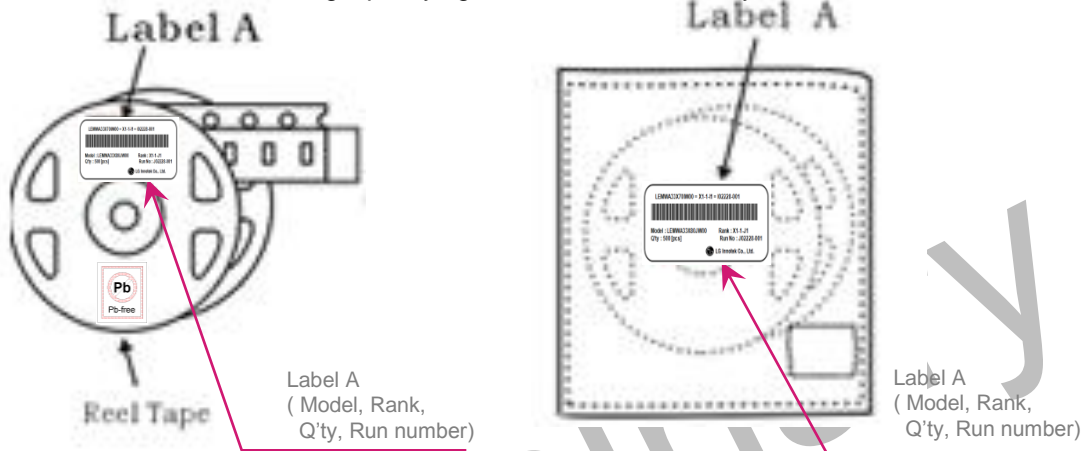


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9-2. Package

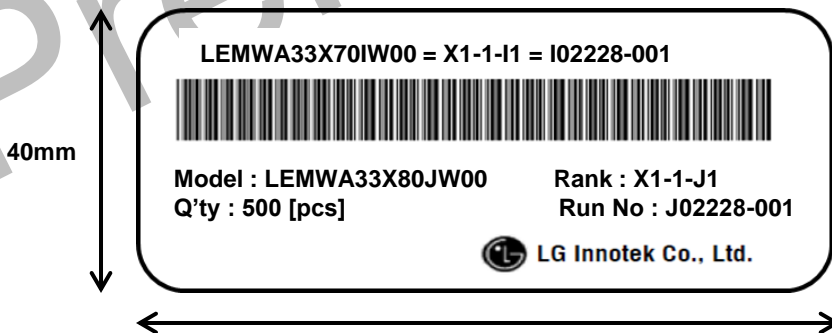
Products are packed in one bag of 500 pcs (one taping reel) and a label is affixed on each bag specifying Model , Rank, Quantity and Run number.



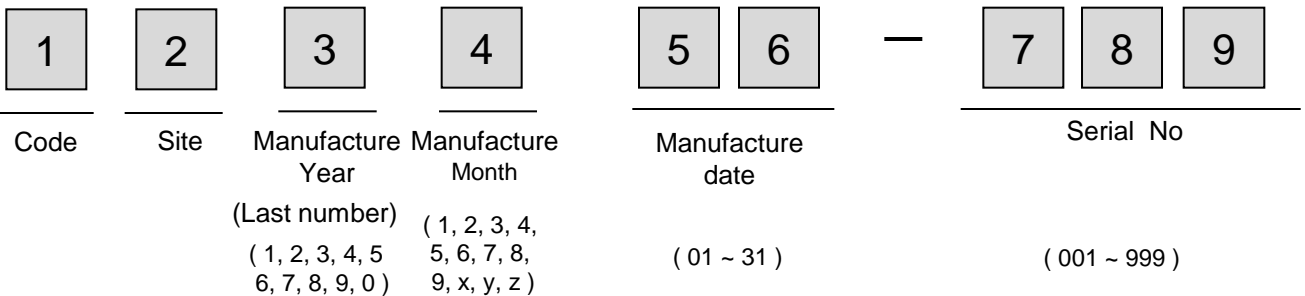
- Package : damp-proof package made of aluminum

※. Label A

Specifying Model Name, Rank, Rank, Quantity and Run number



▪ Run No indication

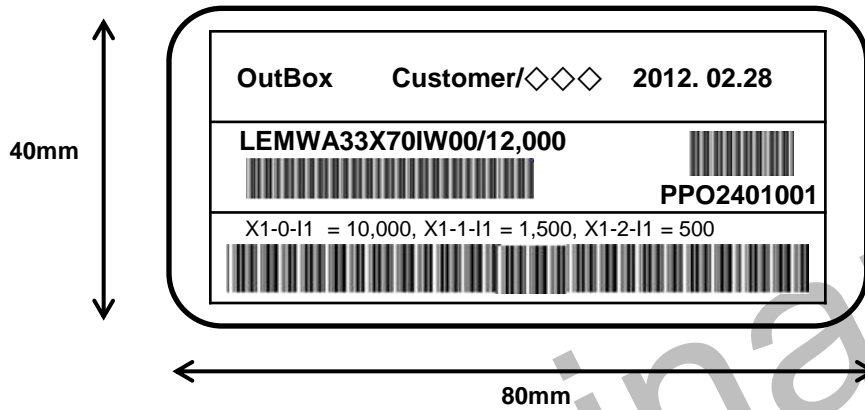


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※. Label B

Specifying Customer, Model, Customer Part no, Lot No, Quantity



▪ Outbox ID. indication

| | | | | | | | | | |
|------|----------|--------|--------|-----------|------------|---|---|---------------|----|
| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 |
| Site | PKG Site | Outbox | Year | Month | Date | | | Serial No | |
| | | | 12 : 2 | 1~9 : 1~9 | (01 ~ 31) | | | (001 ~ 999) | |
| | | | 13 : 3 | 10 : A | | | | | |
| | | | 14 : 4 | 11 : B | | | | | |
| | | | 15 : 5 | 12 : C | | | | | |

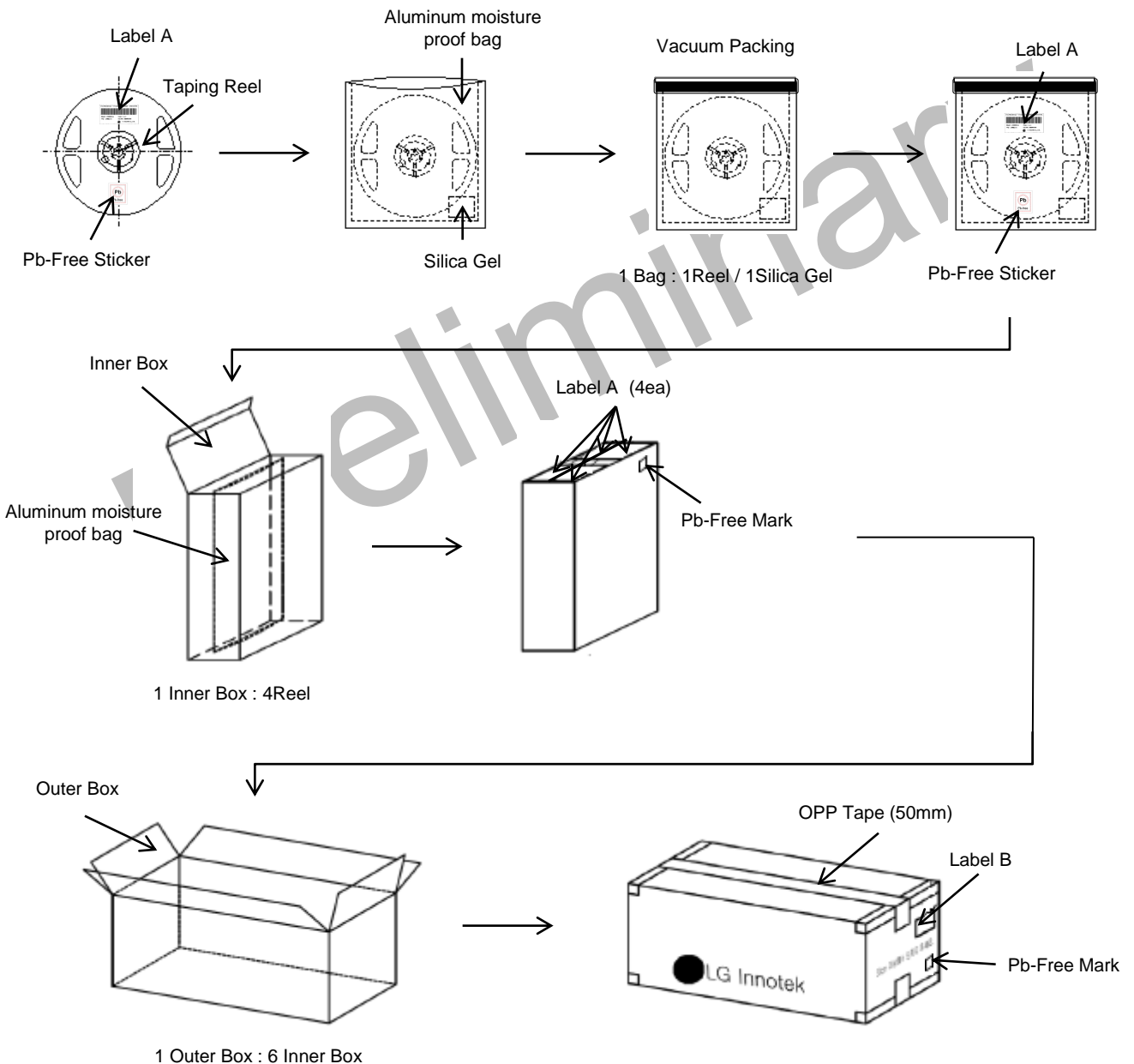
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9-3. Packing Specifications

Reeled products (numbers of products are 500 pcs) packed in a seal off aluminum moisture-proof bag along with desiccants (Silica gel).

Five aluminum bags (total maximum number of products are 2,000 pcs) packed in an inner box and Six inner boxes are put into an outer box.



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10. Cautions on use

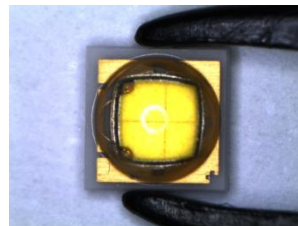
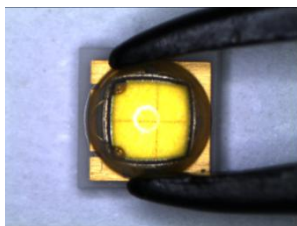
10-1. Moisture Proof Package

- When moisture is absorbed into the SMD package it may vaporize and expand during soldering.
- There is possibility that this can cause exfoliation of the contacts and damage the optical characteristics of the LEDs.

10-2. For the Usage

- LED PKG should not be used in directly exposed environment containing hazardous substances.
- Do not expose the LEDs to corrosive atmosphere during storage and using.
- Avoid rapid transitions in ambient temperature, especially in high humidity.
- In designed a circuit, the current through each LED must not exceed the absolute maximum rating
- Pick and Place
Use teflon tweezers to grab these products LEDs at the base. Do not touch the encapsulating resin (Lens) with the teflon tweezers. Do not touch the lens with fingers. Do not place pressure on the encapsulating resin (lens).


WRONG




CORRECT

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10-3. For the Storage

Before opening the package

- Proper temperature and RH conditions for storage are : 5°C~35°C , less than 60% RH
- Do not open Moisture-Proof bag before the products are ready to use.

After opening the package

- Proper temperature and RH conditions for storage are : 5°C~35°C , less than 60% RH.
- The LEDs should be soldered within 168hours (7days) after opening the package.
- If unused LEDs remain, they should be stored in moisture-proof bag with a absorbent Material. (ex. Silica Gel)
- If the Moisture absorbent material(ex. Silica Gel) loses its color or the LEDs have exceeded the storage time, baking treatment should be performed using the following condition.
Conditions for baking : 60±5°C , 20% RH and 24 hours maximum

10-4. Cleaning

- Please avoid using a brush for cleaning and do not wash the product in organic solvents such as acetone, organic solvent (TCE, etc..) will damage the resin of the LEDs.
- It is recommended the IPA be used as a solvent for cleaning the LEDs. Please refer to following solvents and conditions.
Cleaning Condition : Solvent : IPA, 25°C max X 60 sec. max
- Do not clean the LEDs by the ultrasonic, When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition.
- Do not clean th LEDs by the ultrasonic, When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition.
- Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

10-5. Heat Generation

- Thermal design of the end product is of paramount importance.
- Please consider the heat generation of the LED when making the system design.
- The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board.
- It necessary to avoid intense heat generation and operate within the maximum ratings given in the specification.

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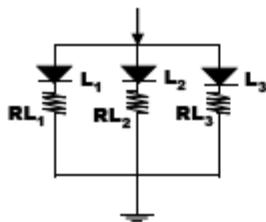
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10-6. Static Electricity

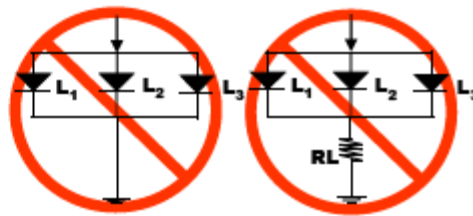
- If over-voltage, which exceeds the absolute maximum rating, is applied to the LEDs, it will damage the LEDs and result in destruction. Since the LEDs are sensitive to the static electricity and surge, it is strongly recommended to use a wristband or anti-electrostatic glove when handling the LEDs and all devices, equipment and machinery must be properly grounded.
- It is recommended that precautions be taken against surge voltage to the equipment the mounts the LEDs.
- Damaged LEDs will show some unusual characteristics such as the leak current remarkable increase, the turn-on voltage becomes lower, or the LEDs do not light at the low current.
- When examining the final product, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. Static-damaged LEDs can easily be found by light-on test or the V_F test at a low current.

10-7. Recommended Circuit

- In designed a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED.
- In general, the LEDs have a variation of forward voltage. Using LEDs with different forward voltages in a circuit with on resistor for the complete circuit causes different forward current for each LED. This may lead to a variation in brightness. In the worst case, some LED may be subjected to the stresses in excesses of the absolute maximum rating. To avoid brightness variation of LEDs, the use of matrix circuit with one resistor for each LEDs recommended.



Pic.1 Recommended Circuit in parallel mode
: Separate resistor must be used in each LED



Pic.2 Abnormal Circuit
The Current through the LEDs may vary due to the variation in forward voltage (V_F) of the LEDs

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- LED should be operated in forward bias. A driving Circuit must be designed so that the LED is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the LED, such operation can cause migration resulting in LED damage.
- If reverse voltage is applied to the LEDs, it will damage the Zener diode and LEDs and result in destruction.

10-8. Application limits of LED Driver IC controller

- GaN based LED is relatively weak to electrical damage (such as static electricity and over current stress). Forward leakage of LED occurred by such damage in the forward low current region may result in turn-on-delay of Lighting Module, which is dependent on a specific function of driver IC.
- For reasons mentioned above, minimum current level (source start-up current) of LED driver IC must be more than 0.3mA. LGIT cannot make a guarantee on the LED using in Drive IC with start up current level of < 0.3mA.
- When parallel circuit LED driver IC is applied in Lighting Module, Hot spot may occur in low current operation region (dimming mode) by difference of LED voltage in low current region. So, driver IC with Individual LED controller is recommended.

10-9. Safety Guideline for Human Eyes.

- Users should be cautioned not to stare at the light of this LED product.
- Great care should be taken when viewing directly the LED driven at high current or the LED with optical instruments, which may greatly increase the hazard to your eyes.

10-10. Others

- LG innoek will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit if use to exceed the absolute maximum ratings. Or not keep the matters that demand special attention.
- The LEDs described in this brochure are intended to be used for ordinary electronic equipment.
- Consult LG innotek, sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs, may directly jeopardize life or health.
- The customer shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from LG innotek. When defective LEDs are found, the customer shall inform LG Innotek disassembling or analysis.
- The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- The appearance and specification of the product may be modified for improvement without notice.

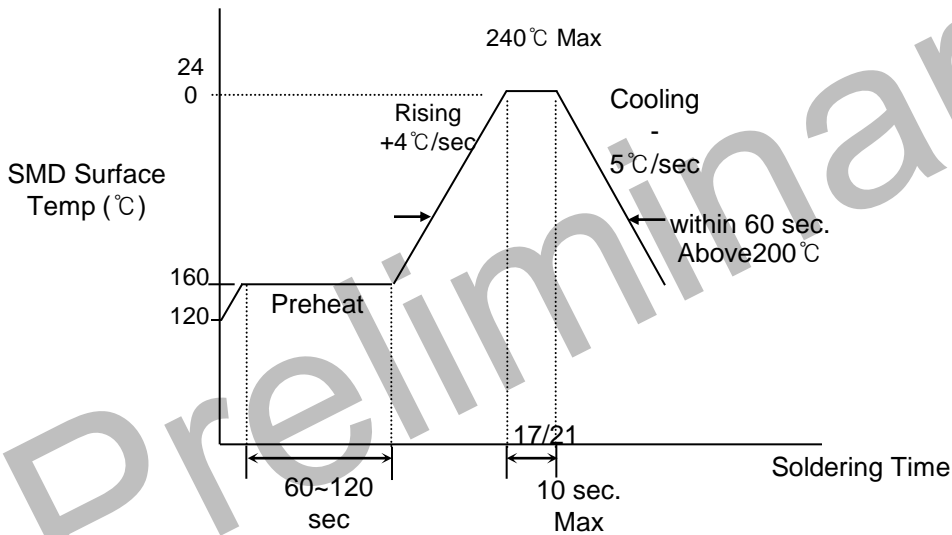
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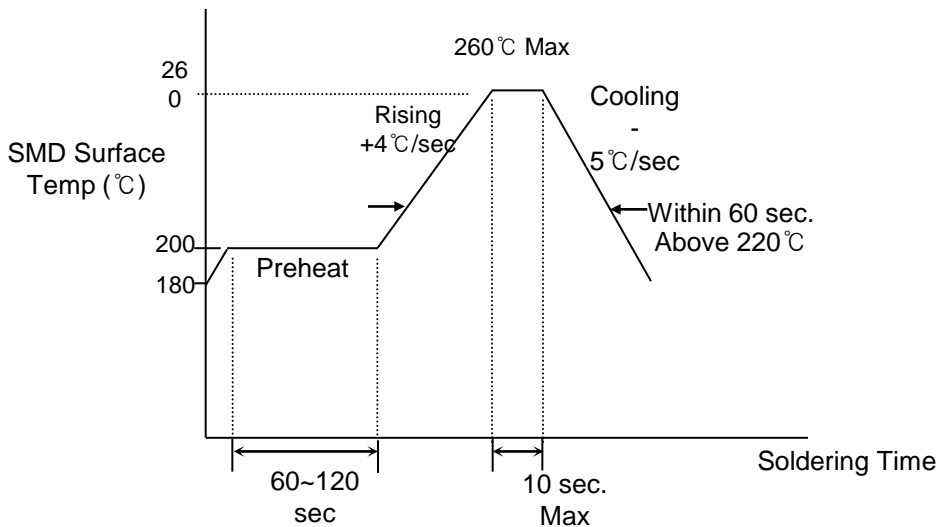
11.Reflow Soldering Characteristics

- The LEDs can be soldered in place using the reflow soldering method.
- LG innotek cannot make a guarantee on the LEDs after they have been assembled using dip soldering method.
- Recommended soldering conditions.

11-1. Pb Solder



11-2. Pb Free Solder



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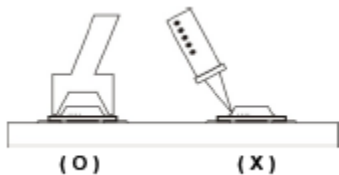
- Although the recommended soldering conditions are specified in the front page diagram, reflow or hand soldering at the lowest possible temperature is desirable for the LEDs.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Occasionally there is a brightness decrease caused by the influence of heat of ambient atmosphere during air flow. It is recommended that the customer use the nitrogen reflow method.
- The encapsulated material of the LEDs is silicone, therefore the LEDs have a soft surface on the top of the LEDs(Lens) . Precautions should be taken to avoid the strong pressure on the encapsulated part. (Lens) So when using the chip mounter, the picking up nozzle that does not affect the silicone resin (Lens) should be used.
- Reflow soldering should not be done more than two times.

11-3. Soldering Iron

- Basic spec is ≤ 5 sec when 260°C
- If temperature is higher, time shorter ($+10^{\circ}\text{C} \rightarrow -1$ sec).
- Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C .

11-4. Repair

- Repairing should not be done after the LEDs have been soldered.
- When repairing is unavoidable, a double-head soldering iron should be used.
- It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- When soldering, do not put stress on the LEDs during heating customer must finish rework within 5sec. Under 245°C .
- The head of Iron can not touch copper foil.
- Twin-head type is preferred.

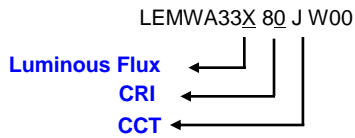


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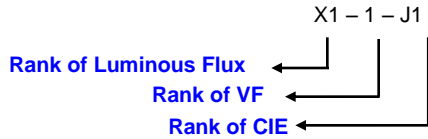
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12. Appendix

※ Model name method: Please refer to the following example Model Name



※ Rank name method: Please refer to the following example Rank Name



▪ Performance Groups of Voltage (@350mA)

| Rank | VF (V, @ 350mA) | | |
|------|-----------------|-----|-----|
| | Min | Typ | Max |
| 0 | 2.9 | - | 3.0 |
| 1 | 3.0 | - | 3.1 |
| 2 | 3.1 | - | 3.2 |

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▪ Performance Groups of Brightness(@350mA)

| Color | CCT Range | | Min. Luminous Flux (lm) | | Order Code |
|------------------|-----------|--------|-------------------------|-----------|------------|
| | Min. | Max. | Group | Flux (lm) | |
| Cool White | 5,000K | 9,000K | X2 | 107 | |
| | | | X3 | 114 | |
| | | | X4 | 122 | |
| | | | X5 | 130 | |
| | | | X6 | 139 | |
| | | | | | |
| Neutral White | 3,700K | 5,000K | W3 | 94 | |
| | | | X1 | 100 | |
| | | | X2 | 107 | |
| | | | X3 | 114 | |
| | | | X4 | 122 | |
| | | | X5 | 130 | |
| Warm White | 2,600K | 3,700K | W1 | 81 | |
| | | | W2 | 87 | |
| | | | W3 | 97 | |
| | | | X1 | 100 | |
| | | | X2 | 107 | |
| | | | | | |

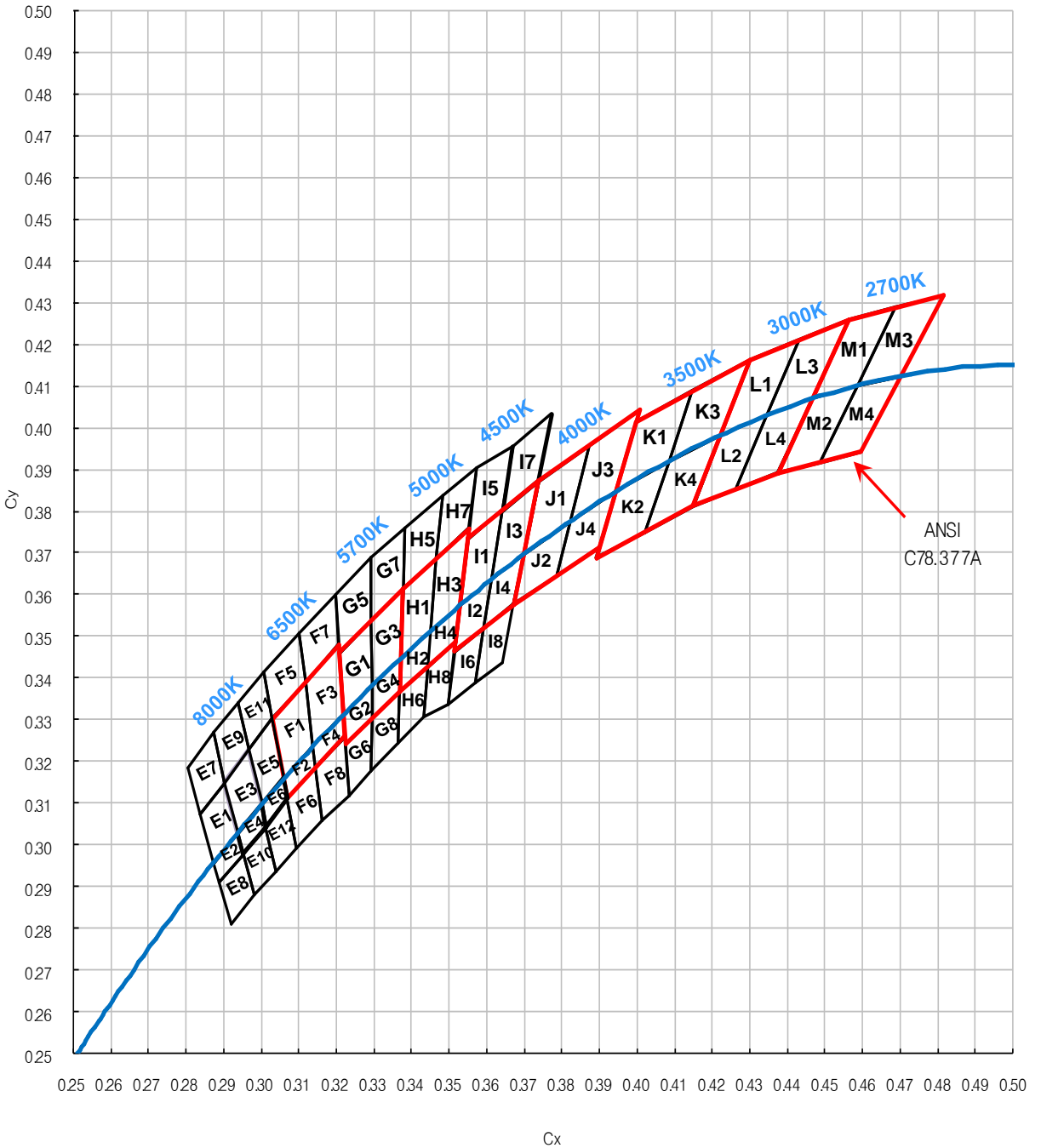
Notes :

- LGIT maintains a tolerance of $\pm 10\%$ on flux and power measurements
- Minimum CRI for Cool White & Neutral White (3,700K – 9,000K CCT) is 70.
- Minimum CRI for Warm White (2,600K – 3,700K CCT) is 80.

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■ Performance Groups of Chromaticity(@350mA)



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| CCT | Rank | CIE X | CIE Y | CCT | Rank | CIE X | CIE Y | CCT | Rank | CIE X | CIE Y |
|---------------------------|------|--------|--------|---------------------------|------|--------|---------|---------------------------|--------|--------|--------|
| 2700K (2725K ±145K) | M1 | 0.4562 | 0.4260 | 3500K (3465K ±245K) | K1 | 0.3996 | 0.4015 | 4500K (4503K ±243K) | I1 | 0.3548 | 0.3462 |
| | | 0.4687 | 0.4289 | | | 0.4146 | 0.4089 | | | 0.3641 | 0.3538 |
| | | 0.4586 | 0.4103 | | | 0.4082 | 0.3922 | | | 0.3611 | 0.3382 |
| | | 0.4465 | 0.4071 | | | 0.3941 | 0.3848. | | | 0.3526 | 0.3314 |
| | M2 | 0.4465 | 0.4071 | | K2 | 0.3941 | 0.3848 | | I2 | 0.3526 | 0.3314 |
| | | 0.4586 | 0.4103 | | | 0.4082 | 0.3922 | | | 0.3611 | 0.3382 |
| | | 0.4483 | 0.3918 | | | 0.4017 | 0.3752 | | | 0.3590 | 0.3305 |
| | | 0.4373 | 0.3893 | | | 0.3889 | 0.3690 | | | 0.3512 | 0.3243 |
| | M3 | 0.4687 | 0.4289 | | K3 | 0.4146 | 0.4089 | | I3 | 0.3641 | 0.3538 |
| | | 0.4813 | 0.4319 | | | 0.4299 | 0.4165 | | | 0.3736 | 0.3616 |
| | | 0.4700 | 0.4126 | | | 0.4221 | 0.3984 | | | 0.3697 | 0.3449 |
| | | 0.4586 | 0.4103 | | | 0.4082 | 0.3922 | | | 0.3611 | 0.3382 |
| | M4 | 0.4586 | 0.4103 | | K4 | 0.4082 | 0.3922 | | I4 | 0.3611 | 0.3382 |
| | | 0.4700 | 0.4126 | | | 0.4221 | 0.3984 | | | 0.3697 | 0.3449 |
| | | 0.4593 | 0.3944 | | | 0.4147 | 0.3814 | | | 0.3670 | 0.3369 |
| | | 0.4483 | 0.3918 | | | 0.4017 | 0.3751 | | | 0.3590 | 0.3305 |
| 3000K (3045K ±175K) | L1 | 0.4299 | 0.4165 | 4000K (3985K ±275K) | J1 | 0.3736 | 0.3874 | I5 | 0.3571 | 0.3602 | |
| | | 0.4430 | 0.4212 | | | 0.3870 | 0.3958 | | 0.3668 | 0.3690 | |
| | | 0.4344 | 0.4032 | | | 0.3819 | 0.3776 | | 0.3641 | 0.3538 | |
| | | 0.4221 | 0.3984 | | | 0.3697 | 0.3697 | | 0.3548 | 0.3462 | |
| | L2 | 0.4221 | 0.3984 | | J2 | 0.3697 | 0.3697 | | I6 | 0.3512 | 0.3243 |
| | | 0.4344 | 0.4032 | | | 0.3819 | 0.3776 | | | 0.3590 | 0.3305 |
| | | 0.4260 | 0.3853 | | | 0.3783 | 0.3646 | | | 0.3567 | 0.3180 |
| | | 0.4147 | 0.3814 | | | 0.3670 | 0.3578 | | | 0.3495 | 0.3120 |
| | L3 | 0.4430 | 0.4212 | | J3 | 0.3870 | 0.3958 | | I7 | 0.3668 | 0.3690 |
| | | 0.4562 | 0.4260 | | | 0.4006 | 0.4044 | | | 0.3771 | 0.3762 |
| | | 0.4465 | 0.4071 | | | 0.3941 | 0.3848 | | | 0.3736 | 0.3616 |
| | | 0.4344 | 0.4032 | | | 0.3819 | 0.3776 | | | 0.3641 | 0.3538 |
| | L4 | 0.4344 | 0.4032 | | J4 | 0.3819 | 0.3776 | | I8 | 0.3590 | 0.3305 |
| | | 0.4465 | 0.4071 | | | 0.3941 | 0.3848 | | | 0.3670 | 0.3369 |
| | | 0.4373 | 0.3893 | | | 0.3898 | 0.3716 | | | 0.3640 | 0.3245 |
| | | 0.4260 | 0.3853 | | | 0.3783 | 0.3646 | | | 0.3567 | 0.3180 |

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| CCT | Rank | CIE X | CIE Y | CCT | Rank | CIE X | CIE Y | CCT | Rank | CIE X | CIE Y |
|---------------------------|--------|--------|--------|----------------------------|--------|--------|--------|---------------------------|------|--------|--------|
| 5000K (5028K ±283K) | H1 | 0.3376 | 0.3616 | 5700K (56650K ±355K) | G1 | 0.3207 | 0.3462 | 6500K (6530K ±510K) | F1 | 0.3028 | 0.3304 |
| | | 0.3463 | 0.3687 | | | 0.3291 | 0.3538 | | | 0.3115 | 0.3391 |
| | | 0.3447 | 0.3513 | | | 0.3292 | 0.3382 | | | 0.3136 | 0.3237 |
| | | 0.3369 | 0.3449 | | | 0.3217 | 0.3314 | | | 0.3059 | 0.3160 |
| | H2 | 0.3369 | 0.3449 | | G2 | 0.3217 | 0.3314 | | F2 | 0.3059 | 0.3160 |
| | | 0.3447 | 0.3513 | | | 0.3292 | 0.3382 | | | 0.3136 | 0.3237 |
| | | 0.3440 | 0.3427 | | | 0.3293 | 0.3305 | | | 0.3144 | 0.3186 |
| | | 0.3366 | 0.3369 | | | 0.3222 | 0.3243 | | | 0.3068 | 0.3113 |
| | H3 | 0.3463 | 0.3687 | | G3 | 0.3291 | 0.3538 | | F3 | 0.3115 | 0.3391 |
| | | 0.3551 | 0.3760 | | | 0.3376 | 0.3616 | | | 0.3205 | 0.3481 |
| | | 0.3526 | 0.3575 | | | 0.3369 | 0.3449 | | | 0.3217 | 0.3314 |
| | | 0.3447 | 0.3513 | | | 0.3292 | 0.3382 | | | 0.3136 | 0.3237 |
| | H4 | 0.3447 | 0.3513 | | G4 | 0.3292 | 0.3382 | | F4 | 0.3136 | 0.3237 |
| | | 0.3526 | 0.3575 | | | 0.3369 | 0.3449 | | | 0.3217 | 0.3314 |
| | | 0.3515 | 0.3487 | | | 0.3366 | 0.3369 | | | 0.3221 | 0.3261 |
| | | 0.3440 | 0.3427 | | | 0.3293 | 0.3305 | | | 0.3144 | 0.3186 |
| | H5 | 0.3381 | 0.3762 | | G5 | 0.3196 | 0.3602 | | F5 | 0.3005 | 0.3415 |
| | | 0.3480 | 0.3840 | | | 0.3290 | 0.3690 | | | 0.3099 | 0.3509 |
| | | 0.3463 | 0.3687 | | | 0.3291 | 0.3538 | | | 0.3115 | 0.3391 |
| | | 0.3376 | 0.3616 | | | 0.3207 | 0.3462 | | | 0.3028 | 0.3304 |
| | H6 | 0.3366 | 0.3369 | | G6 | 0.3222 | 0.3243 | | F6 | 0.3068 | 0.3113 |
| | | 0.3440 | 0.3427 | | | 0.3293 | 0.3305 | | | 0.3144 | 0.3186 |
| | | 0.3429 | 0.3307 | | | 0.3290 | 0.3180 | | | 0.3161 | 0.3059 |
| | | 0.3361 | 0.3245 | | | 0.3231 | 0.3120 | | | 0.3093 | 0.2993 |
| H7 | 0.3480 | 0.3840 | G7 | 0.3290 | 0.3690 | F7 | 0.3099 | 0.3509 | | | |
| | 0.3571 | 0.3907 | | 0.3381 | 0.3762 | | 0.3196 | 0.3602 | | | |
| | 0.3551 | 0.3760 | | 0.3376 | 0.3616 | | 0.3205 | 0.3481 | | | |
| | 0.3463 | 0.3687 | | 0.3291 | 0.3538 | | 0.3115 | 0.3391 | | | |
| H8 | 0.3440 | 0.3427 | G8 | 0.3293 | 0.3305 | F8 | 0.3144 | 0.3186 | | | |
| | 0.3515 | 0.3487 | | 0.3366 | 0.3369 | | 0.3221 | 0.3261 | | | |
| | 0.3495 | 0.3339 | | 0.3361 | 0.3245 | | 0.3231 | 0.3120 | | | |
| | 0.3429 | 0.3307 | | 0.3290 | 0.3180 | | 0.3161 | 0.3059 | | | |

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| CCT | Rank | CIE X | CIE Y | CCT | Rank | CIE X | CIE Y |
|---------------------------|--------|--------|--------|---------------------------|------|--------|--------|
| 8000K (8020K ±980K) | E1 | 0.2835 | 0.3075 | 8000K (8020K ±980K) | E9 | 0.2870 | 0.3270 |
| | | 0.2772 | 0.2992 | | | 0.2803 | 0.3185 |
| | | 0.2807 | 0.2884 | | | 0.2835 | 0.3075 |
| | | 0.2870 | 0.2957 | | | 0.2900 | 0.3150 |
| | E2 | 0.2870 | 0.2957 | | E10 | 0.2950 | 0.2980 |
| | | 0.2807 | 0.2884 | | | 0.2885 | 0.2910 |
| | | 0.2824 | 0.2840 | | | 0.2920 | 0.2810 |
| | | 0.2885 | 0.2910 | | | 0.2980 | 0.2880 |
| | E3 | 0.2900 | 0.3150 | | E11 | 0.2938 | 0.3343 |
| | | 0.2835 | 0.3075 | | | 0.2870 | 0.3270 |
| | | 0.2870 | 0.2957 | | | 0.2900 | 0.3150 |
| | | 0.2935 | 0.3029 | | | 0.2965 | 0.3230 |
| | E4 | 0.2935 | 0.3029 | | E12 | 0.3010 | 0.3045 |
| | | 0.2870 | 0.2957 | | | 0.2950 | 0.2980 |
| | | 0.2885 | 0.2910 | | | 0.2980 | 0.2880 |
| | | 0.2950 | 0.2980 | | | 0.3037 | 0.2937 |
| | E5 | 0.2965 | 0.3230 | | | | |
| | | 0.2900 | 0.3150 | | | | |
| | | 0.2935 | 0.3029 | | | | |
| | | 0.3000 | 0.3100 | | | | |
| | E6 | 0.3000 | 0.3100 | | | | |
| | | 0.2935 | 0.3029 | | | | |
| | | 0.2950 | 0.2980 | | | | |
| | | 0.3010 | 0.3045 | | | | |
| E7 | 0.2803 | 0.3185 | | | | | |
| | 0.2735 | 0.3100 | | | | | |
| | 0.2772 | 0.2992 | | | | | |
| | 0.2835 | 0.3075 | | | | | |
| E8 | 0.2885 | 0.2910 | | | | | |
| | 0.2824 | 0.2840 | | | | | |
| | 0.2860 | 0.2740 | | | | | |
| | 0.2920 | 0.2810 | | | | | |